

138—174 MHz, 100/110-WATT POWER AMPLIFIER
 19C3204I4G3 MOBILE "M" 138—174 MHz
 19C3204I4G6 MOBILE "E" 138—174 MHz
 19C3204I4G8 STATION INTERMITTENT DUTY, 150.8—174 MHz
 19C3204I4G9 STATION INTERMITTENT DUTY, 138—155 MHz
 19D4I7524G2 STATION CONTINUOUS DUTY, 138—155 MHz
 19D4I7524G4 STATION CONTINUOUS DUTY, 150.8—174 MHz

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DESCRIPTION

The PA assembly uses seven RF power transistors to provide 100 watts output power for MASTR® Executive II and 110 watts output power for MASTR II. The output power is adjustable over a range of 30 to 100 watts for MASTR Executive II and 35 to 110 watts for MASTR II. Seven transistors are used in the power control circuit.

CAUTION

Mobile and Station Power Amplifiers ARE NOT interchangeable due to different chassis grounding requirements.

In Station applications, the chassis ground and PA board ground are common.

In Mobile applications, the PA board is isolated from vehicle ground.

Supply voltage for the PA is connected through power leads (from the system-audio-squelch board (SAS) on MASTR Executive II and from the system board on MASTR II) to feedthrough capacitors C297 and C298 on the bottom of the PA assembly. C297, C298, C299, L295 and L296 prevent RF from getting on the power leads. Diode CR295 will cause the main fuse in the fuse assembly to blow if the polarity of the power leads is reversed, providing reverse voltage protection for the radio.

The PA assembly is insulated from vehicle ground to permit operation in positive or negative ground vehicles.

NOTE

In positive ground vehicles, A- is "hot" with respect to vehicle ground. Shorting the transmitter PA printed wiring board ground pattern to the radio case may cause one of the in-line fuses to blow.

Centralized metering jack J205 is provided for use with GE Test Set Model 4EX3A11 or Test Kit 4EX8K12. The Test Set meters the Ampl-1 drive (exciter output), Ampl-1 voltage, driver current, PA current and PA voltage.

CIRCUIT ANALYSIS

RF AMPLIFIERS

The exciter output is coupled through an RF cable to PA input jack J201. The RF is coupled through a matching network to the base of Class C amplifier Q201. The network matches the 50-ohm input to the base of Q201, and consists of T201, C203, C204 and L202. R201, L201, and C275 are a stabilizing network in the base circuit of Q201.

Part of the RF input is rectified by CR201 and is applied to voltage dividers R202, R231 and R203. The voltage is divided to activate the Power Control circuit and for metering the Ampl-1 drive at J205.

Collector voltage to Q201 (Ampl-1) is controlled by the Power Control circuit, and is applied through a collector stabilizing network (L213 and R213) and collector feed network T202 and C276. The collector voltage of Q201 is metered through R212 at J205.

The output of Q201 is coupled to the base of the second class C amplifier (Q202) through a matching network consisting of T202, C210, T203, C211 and C212. Collector voltage to Q202 is applied through collector stabilizing network L226 and R232 and collector feed network L203 and C17.

The output of Q202 is applied to the base of Class C driver Q203 through a low-pass filter matching network (L220, C218, C220 and C221). Collector voltage to Q203 is coupled through collector stabilizing network Z202 and collector feed network L204 and C225.

Collector current for Q203 is metered across tapped manganin resistor R215 at J205 (Driver Current). The reading is taken on the one-volt scale with the High Sensitivity button pressed, and read as 10 amperes full scale.

Following Q203 is a matching network (L221, C227, C4209, T204 and C229) that matches the output of Q203 to the 50-ohm microstrip impedance (W207) to the input of power divider Z207.

The power amplifier stages consist of four identical paralleled Class C PA circuits (Q204 through Q207). The output of Z207 is coupled through impedance-matching networks T205-C230 and T206-C231 to additional power dividers Z208 and Z209. Z208 provides drive for PA transistors Q204 and Q205, while Z209 provides drive for Q206 and Q207.

One output of Z208 is applied to the base of Q204 through an impedance matching network (T207, C236, C240 and C241). C265, L214 and R208 are a stabilizing network in the base of Q204. Supply voltage for Q204 is coupled through collector stabilizing network Z203, and collector feed network L205 and C248.

Collector current for Q204 through Q207 is metered across paralleled tapped manganin resistors R207 and R216. The reading is taken on the one-volt scale with the High Sensitivity button pressed, and read as 30 amperes full scale.

The output of Q204 is coupled through a matching network (L222, C256, T211 and C260) and added to the output of Q205 in power combiner Z210. The outputs of Q206 and Q207 are coupled through matching networks to power combiner Z211. Following Z210 and Z211 are impedance-matching networks (T215-C268 and T216-C269) that match the outputs of Z210 and Z211 to power combiner Z212. The combined PA output is

applied to 50-ohm microstrip W209, and is coupled through a low-pass filter to the antenna through antenna switch K201. Capacitors C278, C279, C280, C223, C232, C226, C223 and C4208 provide isolation for $\pm$ ground operation.

WARNING

The RF Power Transistors used in the transmitter contain Beryllium Oxide, a TOXIC substance. If the ceramic, or other encapsulation is opened, crushed, broken or abraded, the dust may be hazardous if inhaled. Use care in replacing transistors of this type.

POWER CONTROL CIRCUIT

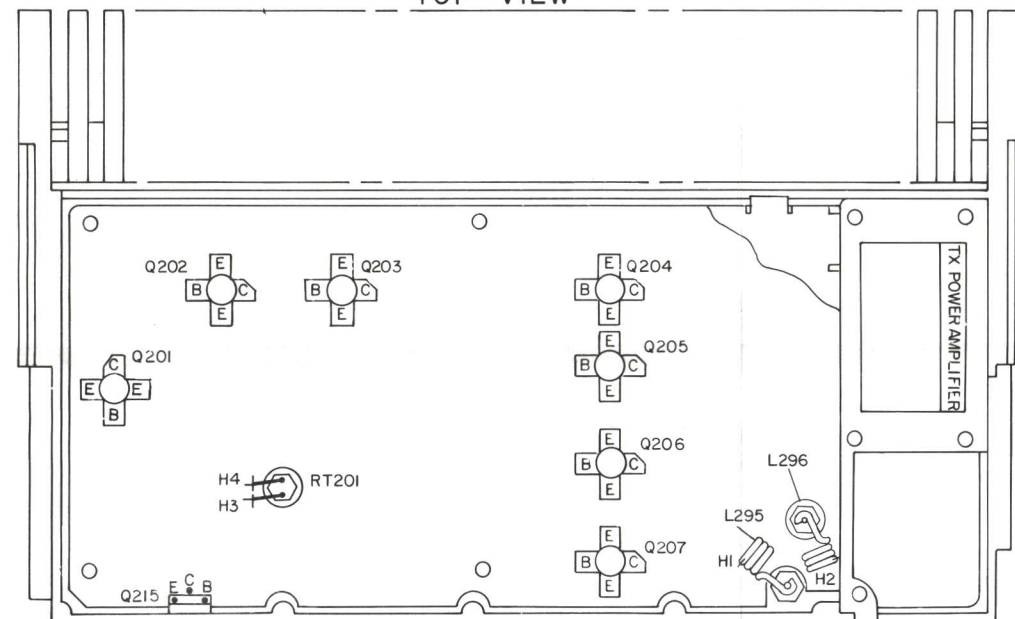
When the transmitter is keyed, rectified RF from CR201 is applied to the base of switch Q208, turning it on. Turning on Q208 turns on voltage regulator Q209, supplying a constant voltage to Power Adjust potentiometer R223.

Q213, Q214 and Q215 operate as an amplifier chain to supply voltage to the collector of Q201 (Ampl-1). The setting of R223 determines the voltage applied to the base of Q214. The higher the voltage at the base of Q214, the harder the amplifiers conduct, supplying more collector voltage to Q201. The lower the voltage at the base of Q214, the less collector voltage is supplied to Q201. Reducing the supply voltage to Q201 reduces the drive to Q202 and Q203, thereby reducing the power output of the PA. The power output can be adjusted by R223 from approximately 30 to 100 watts for MASTR Executive II and 35 to 110 watts for MASTR II.

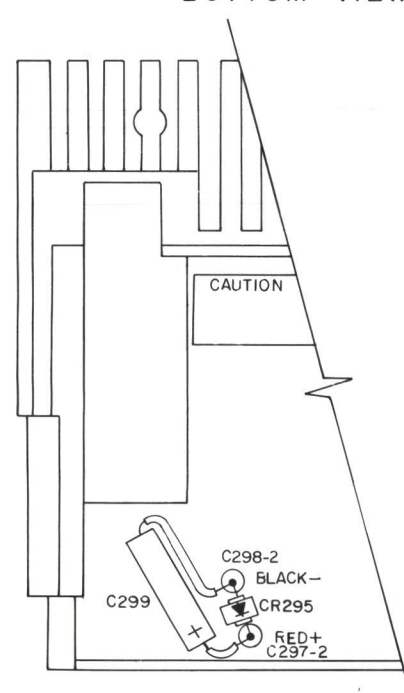
CAUTION

Due to the reduced heat dissipation capability of the MASTR Executive II heat sink assembly, the MASTR Executive II transmitter should not be adjusted above 100 watts.

Temperature protection is provided by Q210, Q211, and thermistor RT201 which is mounted in the PA heatsink. Under normal operating conditions, the circuit is inactive (Q210 is on and Q211 is off). When the heatsink temperature reaches approximately 100°C, the resistance of RT201 decreases. This increases the base voltage applied to Q210, turning it off. Turning off Q210 allows Q211 to turn on, decreasing the voltage at Power Adjust potentiometer R223. This reduces the base voltage to Q214 which causes Q213 and Q215 to conduct less, reducing the collector voltage to Q201 (Ampl-1). This reduces the transmitter output power, keeping the heatsink at approximately 100°C. When the heatsink temperature decreases below 100°C, the temperature control circuit turns off, allowing the normal transmitter power output.

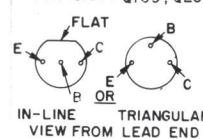
PA ASSEMBLY
TOP VIEW

BOTTOM VIEW



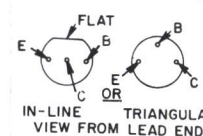
- ▲ 19D416964G 2 & G3
 * 19D416964G3
 ◇ USED ON 19C320414G6 ONLY

LEAD IDENTIFICATION
FOR Q101 - Q109, Q208, Q213, Q214



NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

LEAD IDENTIFICATION
FOR Q201 - Q207, Q209, Q210, & C211

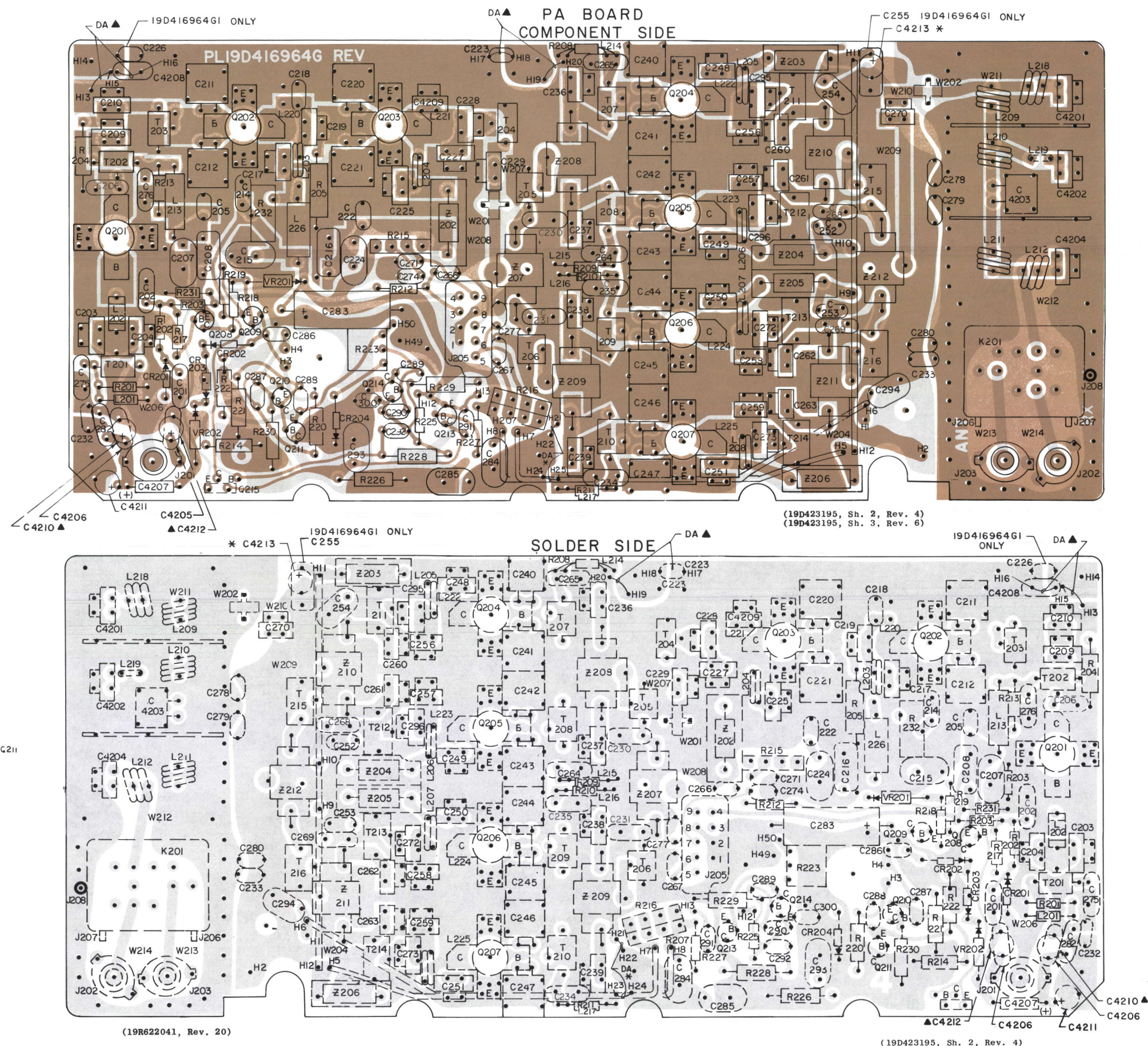


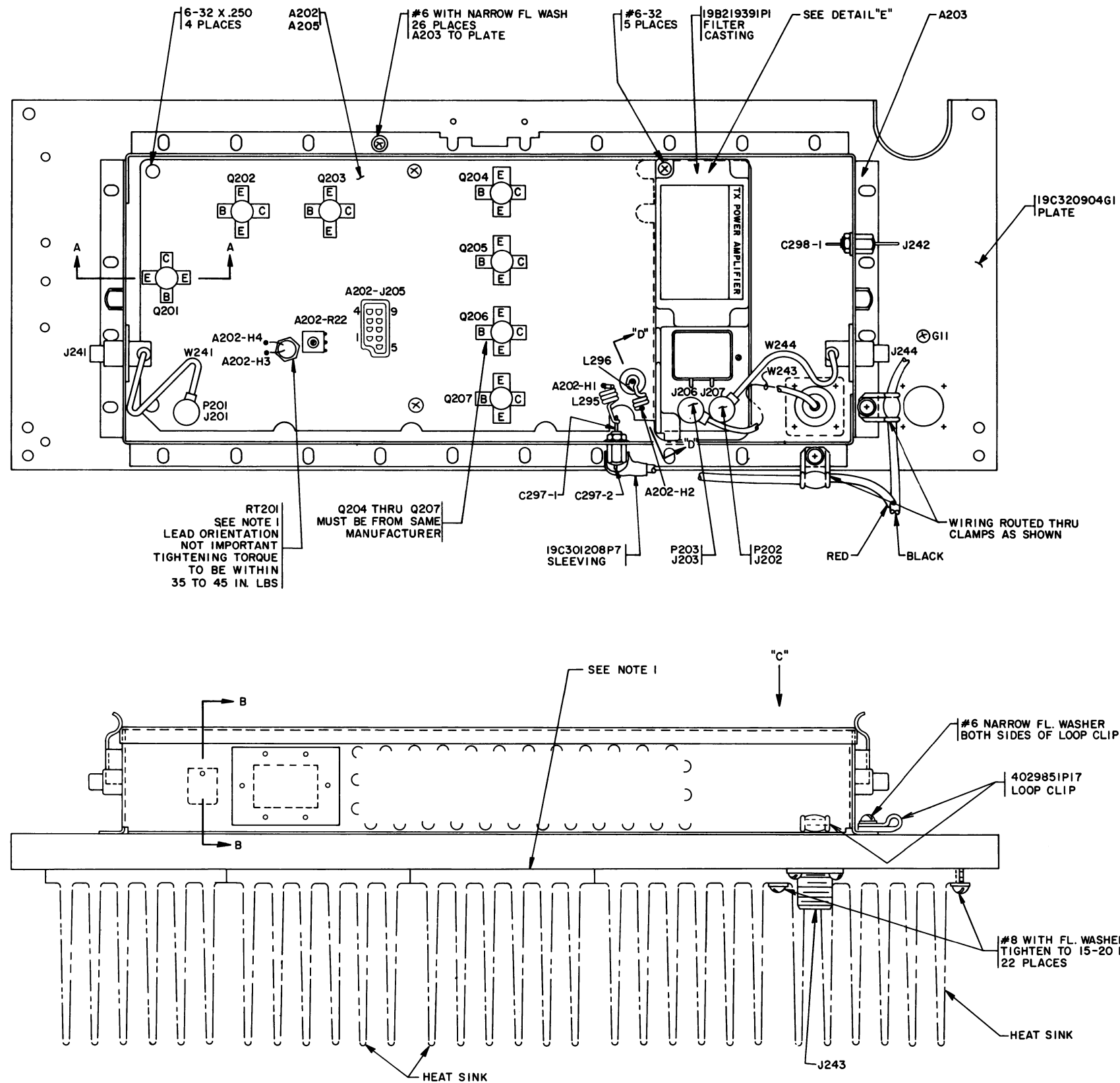
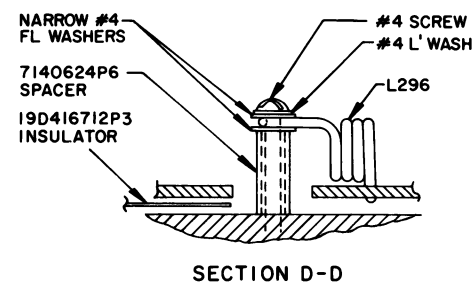
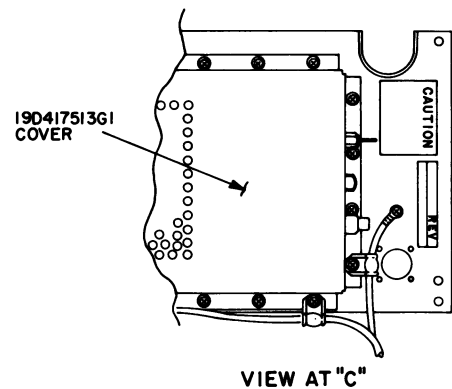
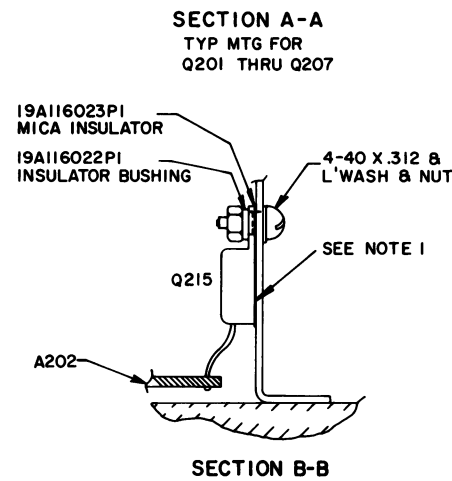
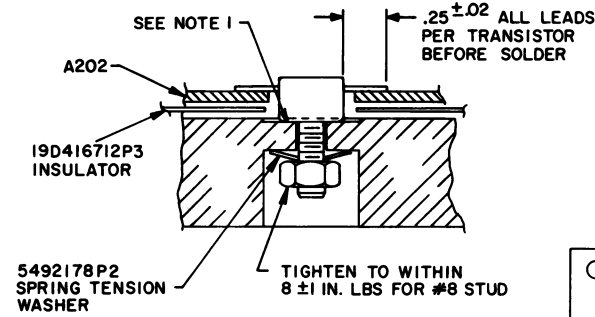
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

- ← RUNS ON SOLDER SIDE
 ← RUNS ON BOTH SIDES
 ← RUNS ON COMPONENT SIDE

OUTLINE DIAGRAM

138—174 MHz, 100/110 WATT
 POWER AMPLIFIER 19C320414G3, G6, G8 & G9
 MOBILE AND INTERMITTENT DUTY STATION

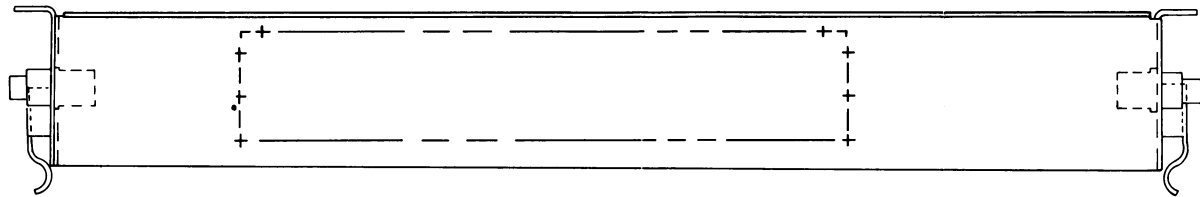




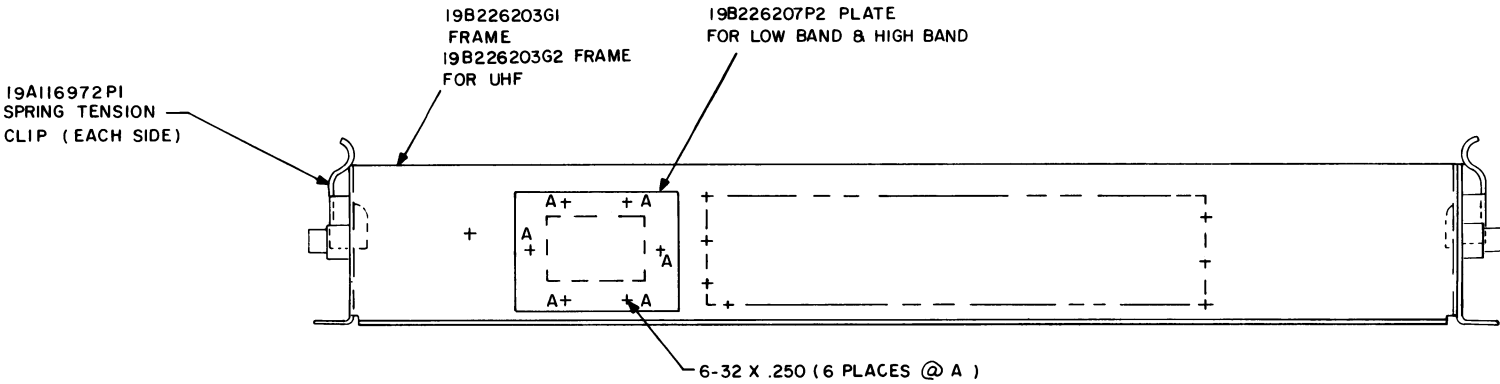
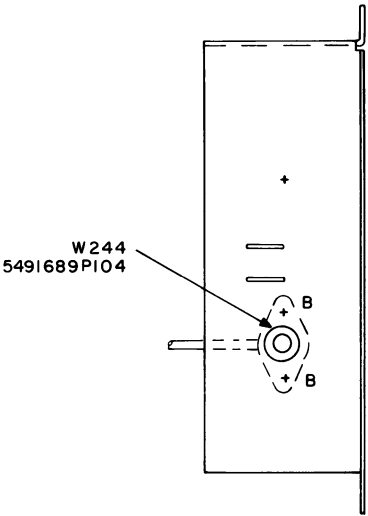
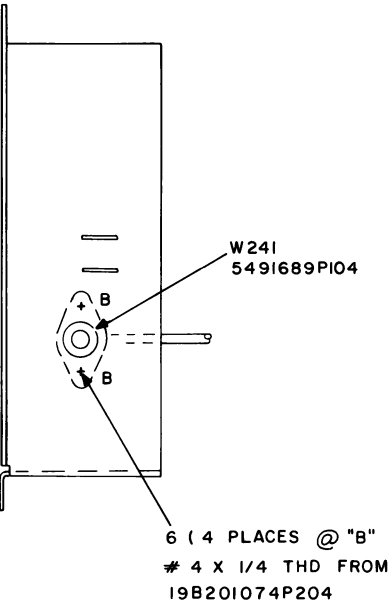
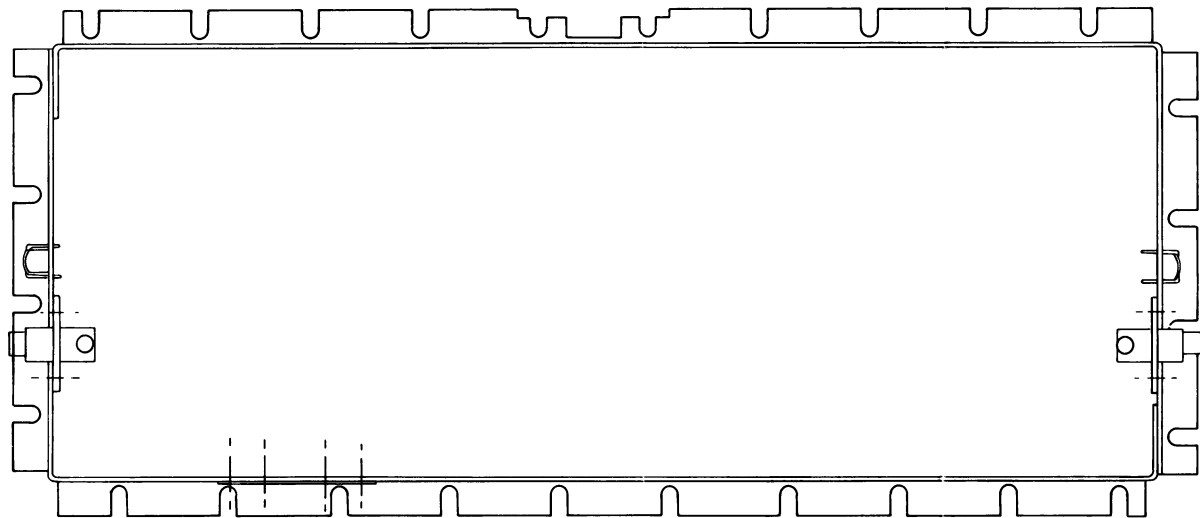
NOTES:
1. APPLY SILICONE GREASE TO BOTH SIDES OF MICA INSULATOR TO MOUNTING SURFACE OF Q201 THRU Q207 & RT201 AND UNPAINTED FLAT SURFACE OF HEAT SINKS.
NO GREASE ALLOWED ON THE THREADED PORTION OF THE MTG STUD.

OUTLINE DIAGRAM

138-174 MHz, 110 WATT POWER AMPLIFIER
19D417524G2 & G4 CONTINUOUS DUTY STATION



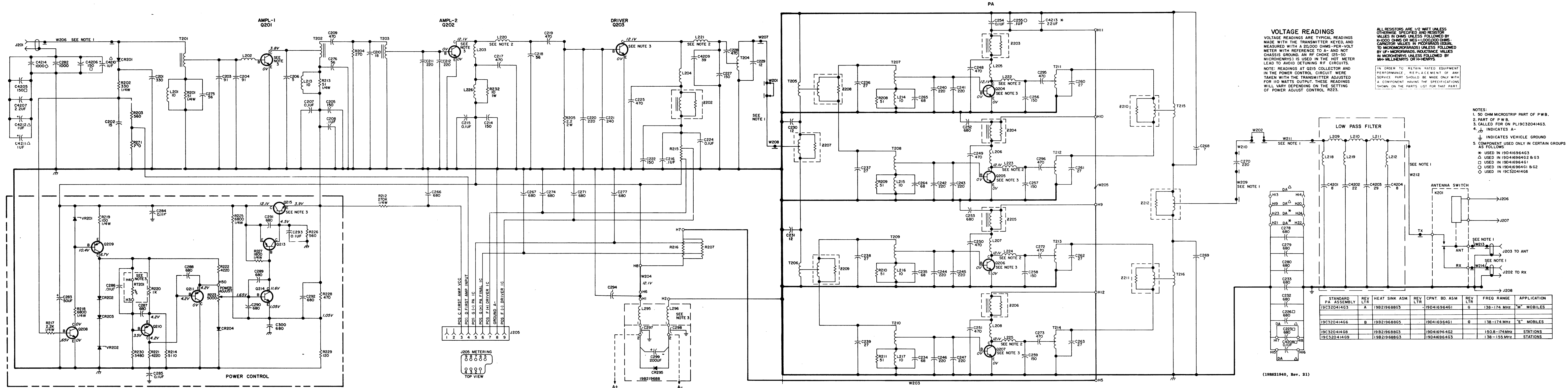
A203



(19D423098, Rev. 0)

OUTLINE DIAGRAM

FRAME ASSEMBLY FOR INTERMITTENT
AND CONTINUOUS DUTY TRANSMITTERS



PARTS LIST		
LBI4557G		
138-174 MHz, 110 WATT POWER AMPLIFIER 19C320414G3 STD PKG 138-174 MHz 19C320414G6 SYS PKG 138-174 MHz 19C320414G8 STATION INTER. DUTY 138-155 MHz 19C320414G9 STATION INTER. DUTY 150.8-174 MHz		
SYMBOL	GE PART NO.	DESCRIPTION
C4214*	5494481P11	----- CAPACITORS ----- Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. Added to G6 by REV B.
	L295 and L296	----- INDUCTORS ----- Coil.
	Q201	----- TRANSISTORS ----- Silicon, NPN; 2.8 watts- power output.
	Q202	Silicon, NPN; 17 watts- power output.
	Q203B	Silicon, NPN; 44 watts- power output.
	Q204 thru Q207	Silicon, NPN; 40 watts- power output.
	Q215	Silicon, NPN.
	WT201	----- THERMISTORS ----- Thermistor: 40K ohms ±20%, color code white; sim to Carborundum Type M0806J-5.
		POWER AMPLIFIER BOARD 19D416964G1 19D416964G2 19D416964G3
	C201	----- CAPACITORS ----- Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C202	7489162P8	Silver mica: 15 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	19A116679P91J	Silver mica: 91 pf ±5%, 250 VDCW.
C203 and C204		
C205*	19A116655P8	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. In REV B and earlier: Silver mica: 470 pf ±5%, 250 VDCW.
C206	19A116679P470J	Silver mica: 5 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C207	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C208*	19A116966P107	Metallized polyester: 0.1 µf ±10%, 50 VDCW. In REV C and earlier: 5496267P13 Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C209	19A116679P470J	Silver mica: 470 pf ±5%, 250 VDCW.
C210	19A116679P18J	Metallized teflon: 18 pf ±5%, 250 VDCW.
C211 and C212	19A116795P220J	Mica: 220 pf ±5%, 250 VDCW.
C214*	19A116655P8	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. In REV B and earlier: Mica: 470 pf ±5%, 250 VDCW.
C215	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C216*	19A116966P107	Metallized polyester: 0.1 µf ±10%, 50 VDCW. In REV C and earlier: 5496267P13 Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C217	19A116679P200J	Mica: 200 pf ±5%, 250 VDCW.

SYMBOL	GE PART NO.	DESCRIPTION
C218*	7489162P21	Silver mica: 56 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15. In REV B & earlier: Mica: 68 pf ±5%, 250 VDCW.
C219	19A116679P68J	Silver mica: 470 pf ±5%, 250 VDCW.
C220	19A116795P220J	Silver mica: 220 pf ±5%, 250 VDCW.
C221	19A116795P240J	Silver mica: 240 pf ±5%, 250 VDCW.
C222*	19A116655P8	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. In REV B & earlier: Silver mica: 470 pf ±5%, 250 VDCW.
C223	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C224	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C225	19A116679P470J	Silver mica: 470 pf ±5%, 250 VDCW.
C226	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C227	19A116679P150J	Silver mica: 150 pf ±5%, 250 VDCW.
C228	19A116679P470J	Silver mica: 470 pf ±5%, 250 VDCW.
C229	19A116679P12J	Metallized teflon: 12 pf ±5 pf, 250 VDCW.
C230 and C231	7489162P7	Silver mica: 12 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C232 and C233	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C234 and C235	7489162P23	Silver mica: 68 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C236 thru C239	19A116679P27J	Metallized teflon: 27 pf ±5%, 250 VDCW.
C240 thru C247	19A116795P220J	Mica: 220 ohms ±5%, 250 VDCW.
C248 thru C251	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C252 and C253	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C254	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C255*	19A116966P107	Metallized polyester: .1 µf, ±10%, 50 VDCW. In REV C and earlier: 5496267P13 Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C256 thru C259	19A116679P150J	Mica: 150 pf ±5%, 250 VDCW.
C260 thru C263	19A116679P27J	Metallized teflon: 27 pf ±5%, 250 VDCW.
C264 and C265	7489162P23	Silver mica: 68 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C266 and C267	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C268 and C269	7489162P3	Silver mica: 7 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C270	19A116679P220J	Silver mica: 220 pf ±5%, 250 VDCW.
C271	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C272 and C273	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C274	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C275 and C276	7489162P21	Silver mica: 56 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C277 thru C280	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.

SYMBOL	GE PART NO.	DESCRIPTION
C282*	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. In REV B & earlier: Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C283	19A116655P17	Electrolytic: 50 µf +150% -10%, 25 VDCW; sim to Mallory Type TTX.
C284 and C285	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C286	19A116080P101	Polyester: 0.01 µf ±20%, 50 VDCW.
C288 thru C292	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C293	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C294*	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW. Added by REV C.
C295 and C296	19A116679P470J	Silver mica: 470 pf ±5%, 250 VDCW.
C300*	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. Added by REV C.
C4201	19A116679P8D	Metallized teflon: 8 pf ±5 pf, 250 VDCW.
C4202	19A116679P22J	Metallized teflon: 22 pf ±5%, 250 VDCW.
C4203	19A116795P29J	Metallized teflon: 29 pf ±5%, 250 VDCW.
C4204	19A116679P8D	Metallized teflon: 8 pf ±5 pf, 250 VDCW.
C4205 and C4206	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C4207	5496267P13	Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C4208	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C4209	19A116679P39J	Metallized teflon: 39 pf ±5%, 250 VDCW.
C4210 thru C4212	19A134202P1	Tantalum: 1 µf ±20%, 35 VDCW.
C4213	19A134202P6	Tantalum: 22 µf ±20%, 15 VDCW.
CR201*	19A116052P2	----- DIODES AND RECTIFIERS ----- Silicon, hot carrier: Fwd. drop .410 volts max. In REV D & earlier: Silicon, fast recovery, 225 mA, 50 PIV.
CR202 thru CR204	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.
J201 thru J203	19A130924G1	----- JACKS AND RECEPTACLES ----- Receptacle, coaxial: sim to Cinch 14H11613.
J205	19B219374G1	Connector: 9 contacts. (Part of K201).
J206 and J207		
J208	4033513P4	Contact, electrical: sim to Bead Chain L93-3.
K201	19A116722P1	----- RELAYS ----- Hermetic sealed: 125 ohms ±20%, 1 form C contact, 9.6 to 15.8 VDC (over the temp range indicated). ----- INDUCTORS -----
L201	19B209420P125	Coil, RF: 10.0 µh ±10%, 3.10 ohms DC res max; sim to Jeffers 4446-4K.
L202	19A129616P1	Strap.
L203 thru L208	19A129561P1	Coil.
L209 thru L211	19A129569P1	Coil.
L212	19A129570P1	Coil.
L213	7488079P43	Choke, RF: 10.0 µh ±10%, 0.30 ohms DC res max; sim to Jeffers 4422-4K.
L214 thru L217	19B209420P125	Coil, RF: 10.0 µh ±10%, 3.10 ohms DC res max; sim to Jeffers 4446-4K.
L218	19A129570P1	Coil.

SYMBOL	GE PART NO.	DESCRIPTION
L219	19A129575P1	Coil.
L220 thru L225		(Part of 19D423195P1 printed wiring board).
L226*	19A129346G1	Coil. Added by REV C.
Q208	19A115910P1	----- TRANSISTORS ----- Silicon, NPN; sim to Type 2N3904.
Q209 thru Q211	19A115768P1	Silicon, PNP; sim to Type 2N3702.
Q213	19A129187P1	Silicon, PNP.
Q214	19A115720P1	Silicon, NPN; sim to Type 2N2222.
R201	3R152P510J	----- RESISTORS ----- Composition: 51 ohms ±5%, 1/4 w.
R202	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.
R203*	3R152P561J	Composition: 560 ohms ±5%, 1/4 w. In REV B & earlier: Composition: 820 ohms ±5%, 1/4 w.
R204	3R152P821J	Composition: 270 ohms ±5%, 1/2 w.
R205	19B209022P123	Wirewound: 2.2 ohms ±10%, 2 w; sim to IRC Type BWH.
R207	19C320212P1	Shunt resistor.
R208 thru R211	3R77P910J	Composition: 51 ohms ±5%, 1/2 w.
R212	3R152P274J	Composition: 0.27 megohm ±5%, 1/4 w.
R213	3R152P510J	Composition: 51 ohms ±5%, 1/4 w.
R214	19A116278P269	Metal film: 5110 ohms ±5%, 1/2 w.
R215	19C320212P2	Shunt resistor.
R216	19C320212P1	Shunt resistor.
R217	3R152P222J	Composition: 2.2K ohms ±5%, 1/4 w.
R218	3R152P682J	Composition: 6.8K ohms ±5%, 1/4 w.
R219	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
R220	19A116278P201	Metal film: 1K ohms ±5%, 1/2 w.
R221 and R222	19A116278P261	Metal film: 4.2K ohms ±5%, 1/2 w.
R223	19A116559P102	Variable, cermet: 5K ohms ±20%, .5 w; sim to CTS Series 360.
R225	3R152P682J	Composition: 6.8K ohms ±5%, 1/4 w.
R226	3R77P561J	Composition: 560 ohms ±5%, 1/2 w.
R227	3R152P182J	Composition: 1.8K ohms ±5%, 1/4 w.
R228	3R77P471J	Composition: 470 ohms ±5%, 1/2 w.
R229	3R77P121J	Composition: 120 ohms ±5%, 1/2 w.
R230	19A116278P253	Metal film: 3.48K ohms ±5%, 1/2 w.
R231*	3R152P271J	Composition: 270 ohms ±5%, 1/4 w. Added by REV C.
R232*	3R78P100K	Composition: 10 ohms ±10%, 1 w. Added by REV C.
T201 thru T203	19A129564G1	----- TRANSFORMERS ----- Coil.
T204	19A129574G1	Coil.
T205 and T206	19A129633G1	Coil.
T207 thru T210	19A129564G1	Coil.
T211 thru T214	19A129574G1	Coil.
T215* and T216*	19A129574G1	Coil. In REV E and earlier: Coil.
	19A129633G1	Coil.

SYMBOL	GE PART NO.	DESCRIPTION
VR201	4036887P1	----- VOLTAGE REGULATORS ----- Silicon, Zener.
VR202	4036887P5	Silicon, Zener.
W201 and W202	19A129571P1	----- CABLES ----- Strap.
W203	19B219885P2	Jumper.
W204	19B219930P1	Jumper.
W205	19C320288P1	Strap, connector. (Part of 19D423195P1 printed wiring board).
W206 thru W214		
Z201*	19B219649G1	----- FILTERS ----- Filter. Deleted by REV C.
Z202 thru Z206	19B219649G1	Filter.
Z207	19A129563G4	Hybrid filter.
Z208 thru Z211	19A129563G3	Hybrid filter.
Z212	19A129563G4	Hybrid filter.
		HEAT SINK ASSEMBLY 19B219688G3 STD PKG 19B219688G15 SYS PKG
C297 and C298	19A116708P1	----- CAPACITORS ----- Ceramic, feed-thru: 0.01 µf ±100 -0%, 500 VDCW; sim to Erie Style 327.
C299	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim to Mallory Type TTX.
CR295	19A116783P1	----- DIODES AND RECTIFIERS ----- Silicon, NPN.
	19D416732G3	Heat sink, casting. (STD PKG).
	19D417105G3	Heat sink, casting. (SYS PKG).
	19B219391G1	Filter casting.
	19D416712P3	Insulator. (Located under Power Amplifier Board).
	19B201074P320	Tap screw: No. 6-32 x 1-1/4. (Secures Filter Casting).
	5492178P2	Washer, spring tension: sim to Wallace Barnes 375-20. (Used with Q201-Q207).
	N207P15C6	Hexnut: No. 8-32. (Used with Q201-Q207).
	19A134016P1	Insulator, bushing. (Used with Q215).
	19A116023P1	Insulator, plate. (Used with Q215).
	19A129361P2	Shield. (Located between L209 and L210, L211).
	19A129639P1	Cover, heat sink. (SYSTEM PACKAGE).

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts list for descriptions of parts affected by these revisions.

REV. A - POWER AMPLIFIER 19C320414G3, G6

REV. A, B & C - POWER AMPLIFIER BOARD 19D416964G1
Incorporated into Initial Shipment.

REV. D - To incorporate new capacitors. Changed C208, C216 and C255.

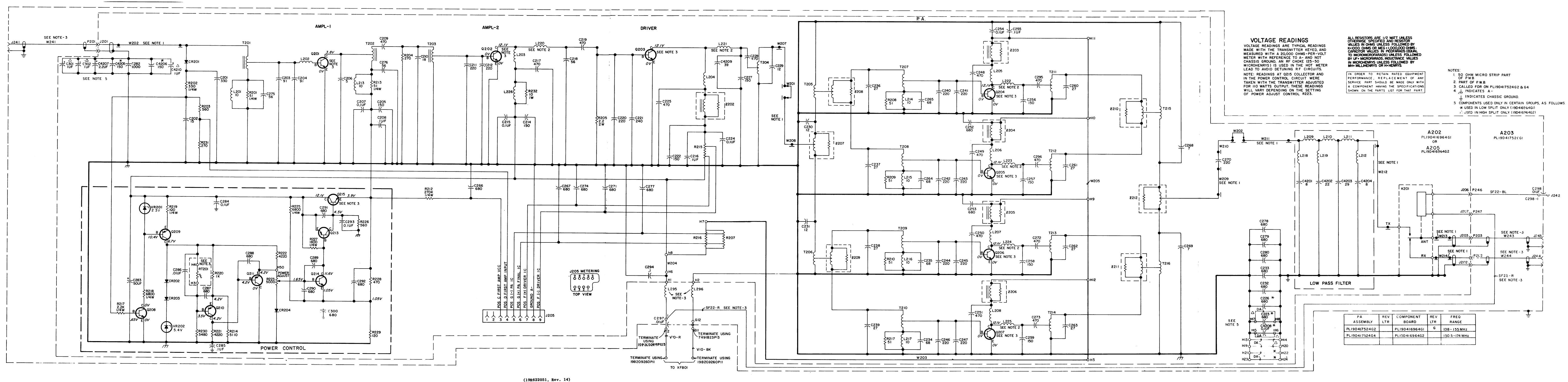
REV. E - To improve operation in cold temperature and wide frequency spacing applications. Changed CR201.

REV. F - To increase power output efficiency at the low end of the band. Changed T215 and T216.

REV. G - To prevent the RF Power output level from changing when the cover is put on the PA. Added C300.

REV. B - POWER AMPLIFIER 19C320414G6

To improve operation in "E" Series Mobiles.
Added C4214.



PARTS LIST		
LBI-4747C 138-174 MHz, 110 WATT POWER AMPLIFIER CONTINUOUS DUTY 19D417524G2 138-155 MHz 19D417524G4 150.8-174 MHz		
SYMBOL	GE PART NO.	DESCRIPTION
A202, A205		POWER AMPLIFIER BOARD A202 19D416964G1 138-155 MHz A205 19D416964G2 150.8-174 MHz
----- CAPACITORS -----		
C201	7489162P39	Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C202	7489162P8	Silver mica: 15 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C203 and C204	19A116679P91J	Mica: 91 pf ±5%, 250 VDCW.
C205*	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
	19A116655P9	In REV B and earlier: Ceramic disc: 100 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C206	7489162P101	Silver mica: 5 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C207	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C208*	19A116966P107	Polyester: 0.1 µf ±10%, 50 VDCW.
	5496267P13	In REV C and earlier: Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C209	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C210	19A116679P18J	Metallized teflon: 18 pf ±5%, 250 VDCW.
C211 and C212	19A116795P220J	Mica: 220 pf ±5%, 250 VDCW.
C214*	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
	19A116655P9	In REV B and earlier: Ceramic disc: 100 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C215	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C216*	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
	19A116966P107	Polyester: 0.1 µf ±10%, 50 VDCW.
	5496267P13	In REV C and earlier: Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C217	19A116679P200J	Mica: 200 pf ±5%, 250 VDCW.
C218	7489162P21	Silver mica: 56 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C219	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C220	19A116795P220J	Mica: 220 pf ±5%, 250 VDCW.
C221	19A116795P240J	Mica: 240 pf ±5%, 250 VDCW.
C222*	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
	19A116655P9	In REV B and earlier: Ceramic disc: 100 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C223	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C224	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C225	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C226	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C227	19A116679P150J	Mica: 150 pf ±5%, 250 VDCW.
C228	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.

SYMBOL	GE PART NO.	DESCRIPTION
C229	19A116679P12J	Metallized teflon: 12 pf ±5%, 250 VDCW.
C230 and C231	7489162P7	Silver mica: 12 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C232 and C233	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C234 and C235	7489162P23	Silver mica: 68 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C236 thru C239	19A116679P27J	Metallized teflon: 27 pf ±5%, 250 VDCW.
C240 thru C247	19A116795P220J	Mica: 220 ohms ±5%, 250 VDCW.
C248 thru C251	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C252 and C253	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C254	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C255*	19A116966P107	Polyester: 0.1 µf ±10%, 50 VDCW.
	5496267P13	In REV C and earlier: Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C256 thru C259	19A116679P150J	Mica: 150 pf ±5%, 250 VDCW.
C260 thru C263	19A116679P27J	Metallized teflon: 27 pf ±5%, 250 VDCW.
C264 and C265	7489162P23	Silver mica: 68 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C266 and C267	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C268 and C269	7489162P3	Silver mica: 7 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C270	19A116679P220J	Mica: 220 pf ±5%, 250 VDCW.
C271	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C272 and C273	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C274	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C275 and C276	7489162P21	Silver mica: 56 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
C277 thru C280	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C282	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C283	19A115680P4	Electrolytic: 50 µf ±150% -10%, 25 VDCW; sim to Mallory Type TTX.
C284 and C285	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C286	19A116080P101	Polyester: 0.01 µf ±20%, 50 VDCW.
C287 thru C292	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C293 and C294	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C295 and C296	19A116679P470J	Mica: 470 pf ±5%, 250 VDCW.
C300*	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. Added by REV G.
C4201	19A116679P8D	Metallized teflon: 8 pf ±.5 pf, 250 VDCW.

SYMBOL	GE PART NO.	DESCRIPTION
C4202	19A116679P22J	Metallized teflon: 22 pf ±5%, 250 VDCW.
C4203	19A116795P29J	Mica: 29 pf ±5%, 250 VDCW.
C4204	19A116679P8D	Metallized teflon: 8 pf ±.5 pf, 250 VDCW.
C4205 and C4206	19A116655P8	Ceramic disc: 150 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
C4207	5496267P13	Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C4208	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
C4209	19A116679P39J	Metallized teflon: 39 pf ±5%, 250 VDCW.
C4210 thru C4212	19A134202P14	Tantalum: 1 µf ±20%, 35 VDCW.
CR201*	19A116052P2	Silicon. In REV D and earlier: Silicon.
CR202 thru CR204	19A115250P1	Silicon.
J201 thru J203	19A130924G1	Receptacle, coaxial: sim to Cinch 14H11613.
J205	19B219374G1	Connector: 9 contacts. (Part of K201).
J206 and J207	4033513P4	Contact, electrical: sim to Bead Chain L93-3.
J208		----- RELAYS -----
K201	19A116722P1	Hermetic sealed: 125 ohms ±20%, 1 form C contact, 9.5 to 15.8 VDC (over the temp range indicated).
L201	19B209420P125	Coil, RF: 10.0 µh ±10%, 3.10 ohms DC res max; sim to Jeffers 4446-4K.
L202	19A129616P1	Strap.
L203 thru L206	19A129561P1	Coil.
L209 thru L211	19A129569P1	Coil.
L212	19A129570P1	Coil.
L213	7488079P43	Choke, RF: 10.0 µh ±10%, 0.30 ohms DC res max; sim to Jeffers 4422-4K.
L214 thru L217	19B209420P125	Coil, RF: 10.0 µh ±10%, 3.10 ohms DC res max; sim to Jeffers 4446-4K.
L218	19A129570P1	Coil.
L219	19A129575P1	Coil.
L220 thru L225		(Part of 19D423195P1 printed wiring board).
L226	19A129346G1	Coil.
Q208	19A115910P1	Silicon, NPN; sim to Type 2N3904.
Q209 thru Q211	19A115768P1	Silicon, PNP; sim to Type 2N3702.
Q213	19A129187P1	Silicon, PNP.
Q214	19A115720P1	Silicon, NPN; sim to Type 2N2222.
R201	3R152P510J	Composition: 51 ohms ±5%, 1/4 w.
R202	3R152P331J	Composition: 330 ohms ±5%, 1/4 w.

SYMBOL	GE PART NO.	DESCRIPTION
R203	3R152P561J	Composition: 560 ohms ±5%, 1/4 w.
R204	3R77P271J	Composition: 270 ohms ±5%, 1/2 w.
R205	19B209022P123	Wirewound: 2.2 ohms ±10%, 2 w; sim to IRC Type BWH.
R207	19C320212P1	Shunt resistor.
R208 thru R211	3R77P510J	Composition: 51 ohms ±5%, 1/2 w.
R212	3R152P274J	Composition: 270K ohms ±5%, 1/4 w.
R213	3R152P510J	Composition: 51 ohms ±5%, 1/4 w.
R214	19A116278P269	Metal film: 5110 ohms ±2%, 1/2 w.
R215	19C320212P2	Shunt resistor.
R216	19C320212P1	Shunt resistor.
R217	3R152P222J	Composition: 2.2K ohms ±5%, 1/4 w.
R218	3R152P682J	Composition: 6.8K ohms ±5%, 1/4 w.
R219	3R152P101J	Composition: 100 ohms ±5%, 1/4 w.
R220	19A116278P201	Metal film: 1K ohms ±2%, 1/2 w.
R221 and R222	19A116278P261	Metal film: 4.22K ohms ±2%, 1/2 w.
R223	19A116559P102	Variable, cermet: 5K ohms ±20%, .5 w; sim to CTS Series 360.
R225	3R152P682J	Composition: 6.8K ohms ±5%, 1/4 w.
R226	3R77P561J	Composition: 560 ohms ±5%, 1/2 w.
R227	3R152P182J	Composition: 1.8K ohms ±5%, 1/4 w.
R228	3R77P471J	Composition: 470 ohms ±5%, 1/2 w.
R229	3R77P121J	Composition: 120 ohms ±5%, 1/2 w.
R230	19A116278P253	Metal film: 3.48K ohms ±2%, 1/2 w.
R231	3R152P271J	Composition: 270 ohms ±5%, 1/4 w.
R232	3R78P100K	Composition: 10 ohms ±10%, 1 w.
T201 thru T203	19A129564G1	Coil.
T204	19A129574G1	Coil.
T205 and T206	19A129633G1	Coil.
T207 thru T210	19A129564G1	Coil.
T211 thru T214	19A129574G1	Coil.
T215* and T216*	19A129574G1	Coil.
VR201	4036887P1	Silicon, Zener.
VR202	4036887P5	Silicon, Zener.
W201 and W202	19A129571P1	Strap.
W203	19B219885P2	Jumper.
W204	19B219930P1	Jumper.
W205	19C320288P1	Strap, connector. (Part of 19D423195P1 printed wiring board).
W206 thru W214		----- RESISTORS -----
Z202 thru Z206	19B219649G1	Filter.

SYMBOL	GE PART NO.	DESCRIPTION
Z207	19A129563G4	Hybrid filter.
Z208 thru Z211	19A129563G3	Hybrid filter.
Z212	19A129563G4	Hybrid filter.
A203		FRAME ASSEMBLY 19D417526G1
W241	5491689P104	Cable, RF: approx 3-5/8 inches long, 350 VVMS, 500 VDC operating voltage.
W244	5491689P104	Cable, RF: approx 3-5/8 inches long, 350 VVMS, 500 VDC operating voltage.
A205		(See A202).
C297 and C298	19A116708P1	Ceramic, feed-thru: 0.01 µf ±100% -0%, 500 VDCW; sim to Erie Style 327.
L295	19A129562P3	Coil.
L296	19A129562P1	Coil.
P246 and P247	4036634P1	Contact, electrical; sim to AMP 42428-2.
Q201	19A134060P1	Silicon, NPN.
Q202	19A134060P2	Silicon, NPN.
Q203B	19A134060P4	Silicon, NPN.
Q204 thru Q207	19A134060P3	Silicon, NPN.
Q215	19A116742P1	Silicon, NPN.
RT201	19A129379G1	Thermistor.
W243	19A129312G6	Cable, antenna: approx 10 inches long.
		----- MISCELLANEOUS -----
	19B226212G1	Heat sink, casting. (Quantity 4).
	19B226212G2	Heat sink, casting. (Quantity 1).
	19B219391G1	Filter casting.
	19D416712P3	Insulator. (Located under Power Amplifier Board).
	5492178P2	Washer, spring tension: sim to Wallace Barnes 375-20. (Used with Q201-Q207).
	19A116022P1	Insulator, bushing. (Used with Q215).
	19A116023P1	Insulator, plate. (Used with Q215).
	N5602P015	"O" Ring. (Used with Q215).
	N402P7C6	Washer: No. 6. (Used with Q215).
	19A12988BP1	Insulator. (Used with Q215).
	19D417513G1	Cover.

PRODUCTION CHANGES

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- POWER AMPLIFIER BOARD 19D416964G1
- REV. A,B&C - Incorporated into Initial Shipment.
- REV. D - To incorporate improved by-pass capacitors. Changed C208, C216 & C255.
- REV. E - To improve performance in cold temperature and wide frequency spacing. Changed CR201.
- REV. F - To increase power output efficiency at the low end of the band. Changed T215 and T216.
- 19D416964G1 POWER AMPLIFIER BOARD
- REV. G - Added capacitor C300 to improve power output level stability.